

# N-Channel and P-Channel Enhancement Mode Power MOSFET

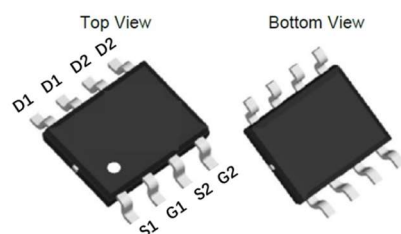
## Features

- N-Channel: 60V, 5A  
 $R_{DS(ON)} < 28\text{ m}\Omega @ V_{GS} = 10\text{V}$   
 $R_{DS(ON)} < 31\text{ m}\Omega @ V_{GS} = 4.5\text{V}$
- P-Channel: -60V, -3.1A  
 $R_{DS(ON)} < 62\text{ m}\Omega @ V_{GS} = -10\text{V}$   
 $R_{DS(ON)} < 72\text{ m}\Omega @ V_{GS} = -4.5\text{V}$

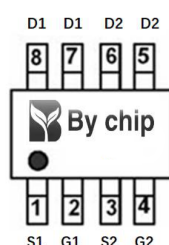
## General Features

- Advanced Trench Technology
- Provide Excellent  $R_{DS(ON)}$  and Low Gate Charge
- Lead Free and Green Available

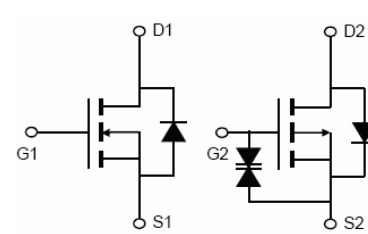
100% UIS TESTED!  
100%  $\Delta V_{ds}$  TESTED!



SOP-8 Dual



Pin Assignment



Schematic diagram

## Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ , unless otherwise noted

| Parameter                                        | Symbol         | NMOS       | PMOS       | Unit             |
|--------------------------------------------------|----------------|------------|------------|------------------|
| Drain-Source Voltage                             | $V_{DS}$       | 60         | -60        | V                |
| Continuous Drain Current                         | $I_D$          | 5          | -3.1       | A                |
| Pulsed Drain Current (note1)                     | $I_{DM}$       | 20         | -12.4      | A                |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 20$   | $\pm 20$   | V                |
| Power Dissipation                                | $P_D$          | 2.5        | 1.9        | W                |
| Operating Junction and Storage Temperature Range | $T_J, T_{stg}$ | -55 To 150 | -55 To 150 | $^\circ\text{C}$ |

## Thermal Resistance

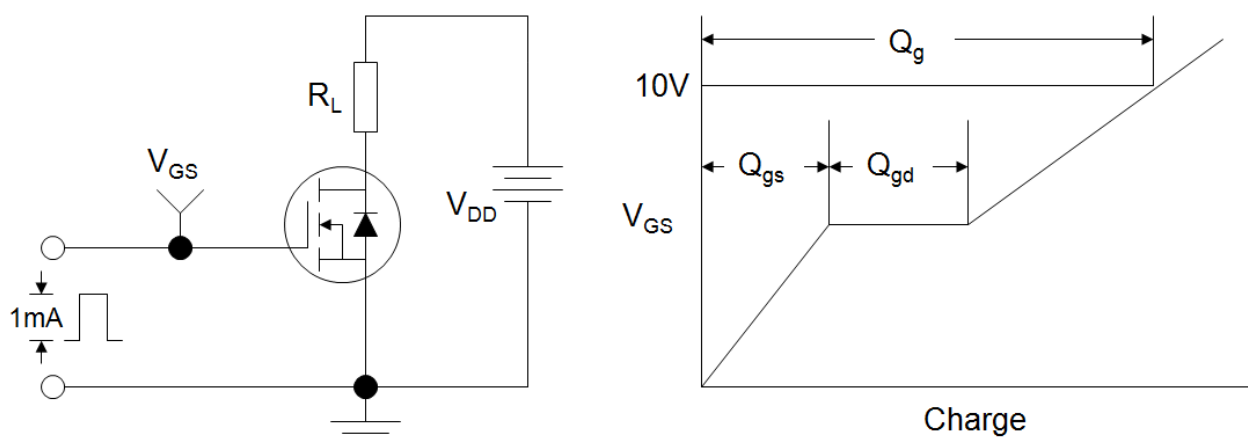
| Parameter                               | Symbol     | NMOS | PMOS | Unit               |
|-----------------------------------------|------------|------|------|--------------------|
| Thermal Resistance, Junction-to-Ambient | $R_{thJA}$ | 50   | 65   | $^\circ\text{C/W}$ |

| NMOS Specifications   T <sub>J</sub> = 25°C, unless otherwise noted |                      |                                                                         |       |      |      |      |
|---------------------------------------------------------------------|----------------------|-------------------------------------------------------------------------|-------|------|------|------|
| Parameter                                                           | Symbol               | Test Conditions                                                         | Value |      |      | Unit |
|                                                                     |                      |                                                                         | Min.  | Typ. | Max. |      |
| Static Parameters                                                   |                      |                                                                         |       |      |      |      |
| Drain-Source Breakdown Voltage                                      | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA                            | 60    | --   | --   | V    |
| Zero Gate Voltage Drain Current                                     | I <sub>DSS</sub>     | V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 25°C      | --    | --   | 1    | μA   |
| Gate-Source Leakage                                                 | I <sub>GSS</sub>     | V <sub>GS</sub> = ±20V                                                  | --    | --   | ±100 | nA   |
| Gate-Source Threshold Voltage                                       | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA              | 1.0   |      | 2.5  | V    |
| Drain-Source On-Resistance                                          | R <sub>DS(on)</sub>  | V <sub>GS</sub> = 10V, I <sub>D</sub> = 4.3A                            | --    |      | 28   | mΩ   |
|                                                                     |                      | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 3.9A                           | --    |      | 31   |      |
| Forward Transconductance                                            | g <sub>FS</sub>      | V <sub>DS</sub> =5V,I <sub>D</sub> =4.3A                                | --    | 9.6  | --   | S    |
| Dynamic Parameters                                                  |                      |                                                                         |       |      |      |      |
| Input Capacitance                                                   | C <sub>iss</sub>     | V <sub>GS</sub> = 0V,<br>V <sub>DS</sub> = 30V,<br>f = 1.0MHz           | --    | 1336 | --   | pF   |
| Output Capacitance                                                  | C <sub>oss</sub>     |                                                                         | --    | 56   | --   |      |
| Reverse Transfer Capacitance                                        | C <sub>rss</sub>     |                                                                         | --    | 52   | --   |      |
| Total Gate Charge                                                   | Q <sub>g</sub>       | V <sub>DS</sub> = 30V,<br>I <sub>D</sub> = 5A,<br>V <sub>GS</sub> = 10V | --    | 22   | --   | nC   |
| Gate-Source Charge                                                  | Q <sub>gs</sub>      |                                                                         | --    | 3.3  | --   |      |
| Gate-Drain Charge                                                   | Q <sub>gd</sub>      |                                                                         | --    | 5.2  | --   |      |
| Turn-on Delay Time                                                  | t <sub>d(on)</sub>   | V <sub>DD</sub> = 30V,<br>I <sub>D</sub> = 5A,<br>R <sub>G</sub> = 3Ω   | --    | 5.2  | --   | ns   |
| Turn-on Rise Time                                                   | t <sub>r</sub>       |                                                                         | --    | 3    | --   |      |
| Turn-off Delay Time                                                 | t <sub>d(off)</sub>  |                                                                         | --    | 17   | --   |      |
| Turn-off Fall Time                                                  | t <sub>f</sub>       |                                                                         | --    | 2.5  | --   |      |
| Drain-Source Body Diode Characteristics                             |                      |                                                                         |       |      |      |      |
| Body Diode Voltage                                                  | V <sub>SD</sub>      | T <sub>J</sub> = 25°C, I <sub>SD</sub> = 1.7A, V <sub>GS</sub> = 0V     | --    | --   | 1.2  | V    |
| Continuous Body Diode Current                                       | I <sub>S</sub>       | T <sub>C</sub> = 25°C                                                   | --    | --   | 5    | A    |

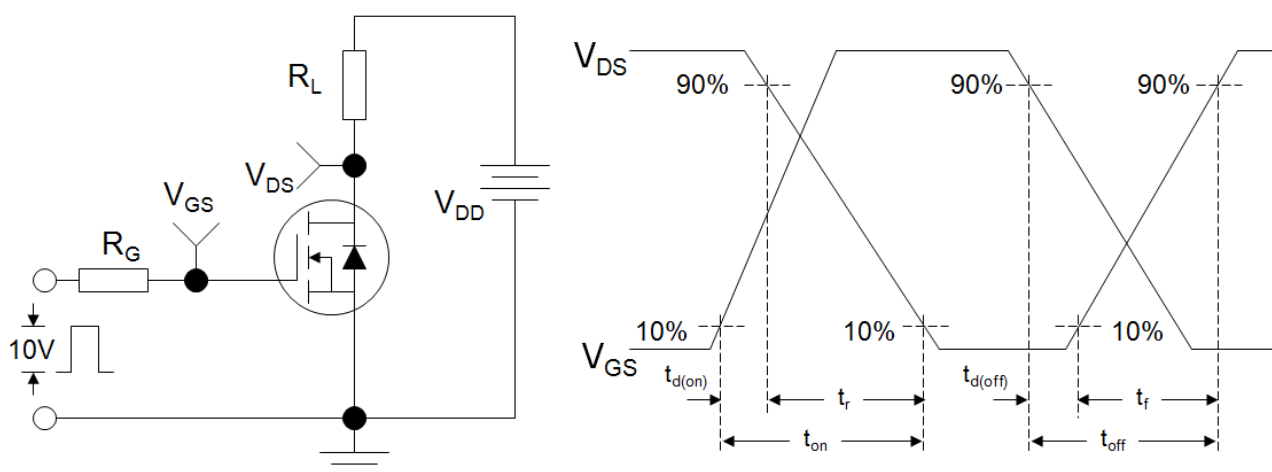
#### Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical  $R_G$

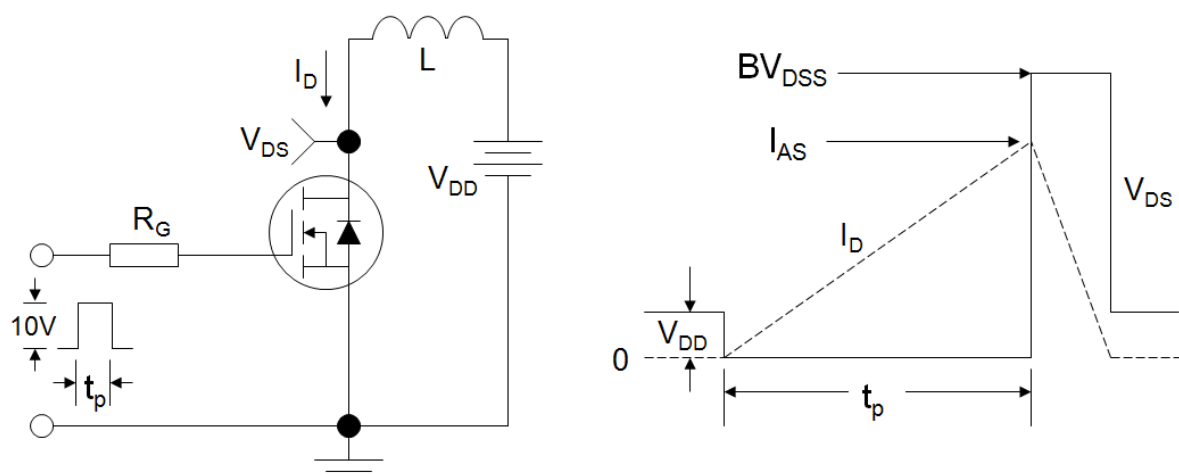
### Gate Charge Test Circuit



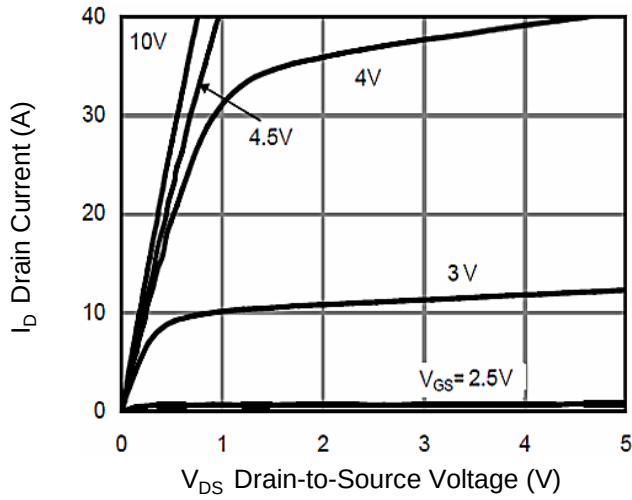
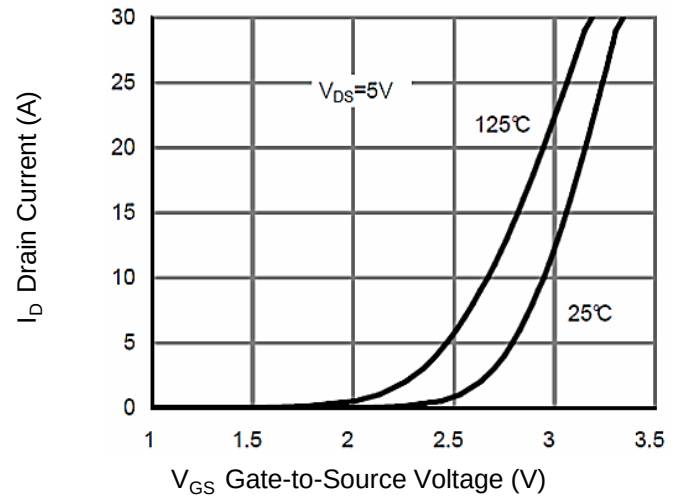
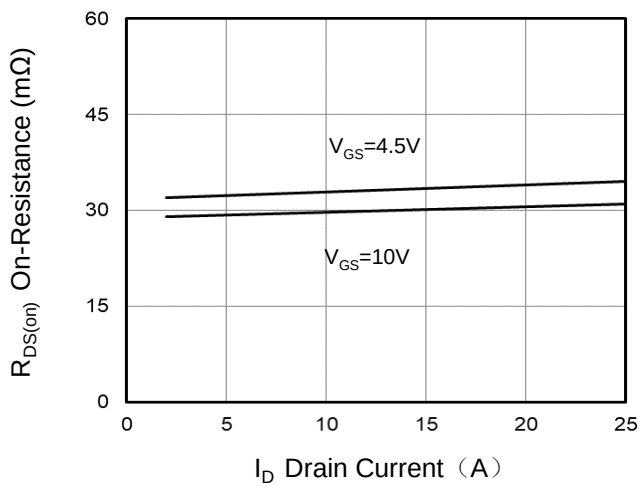
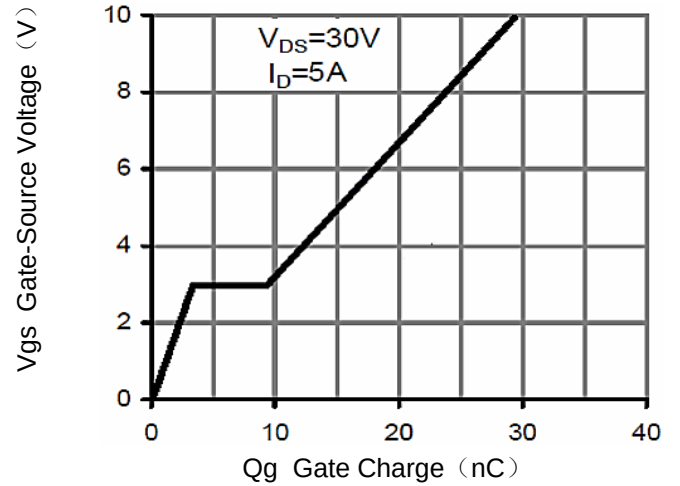
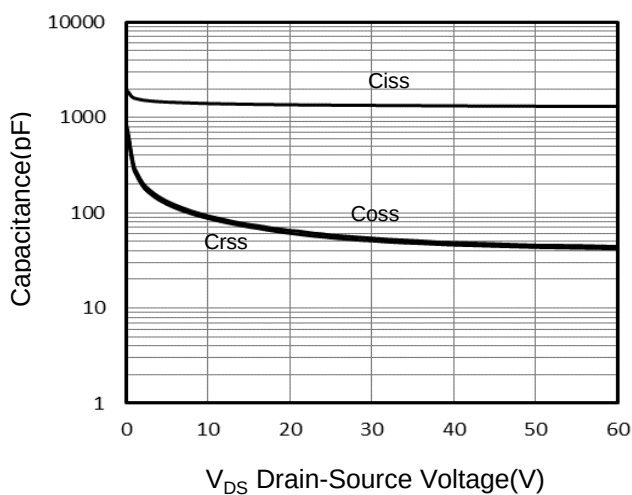
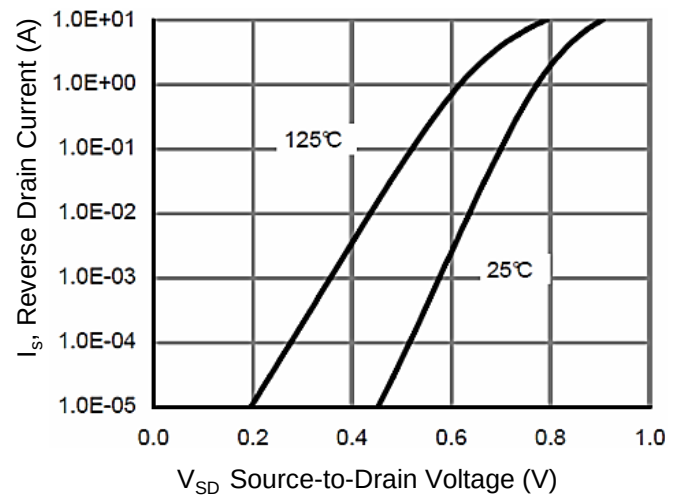
### Switch Time Test Circuit



### EAS Test Circuit



# **NMOS Typical Characteristics** $T_J = 25^\circ\text{C}$ , unless otherwise noted

**Figure 1. Output Characteristics**

**Figure 2. Transfer Characteristics**

**Figure 3. Drain-Source On-Resistance**

**Figure 4. Gate Charge**

**Figure 5. Capacitance**

**Figure 6. Source-Drain Diode Forward**


# NMOS Typical Characteristics $T_J = 25^\circ\text{C}$ , unless otherwise noted

Figure 7. Drain-Source On-Resistance

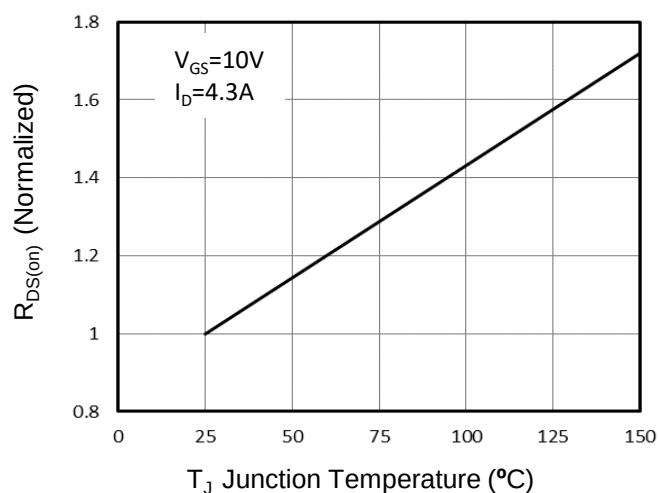


Figure 8. Safe Operation Area

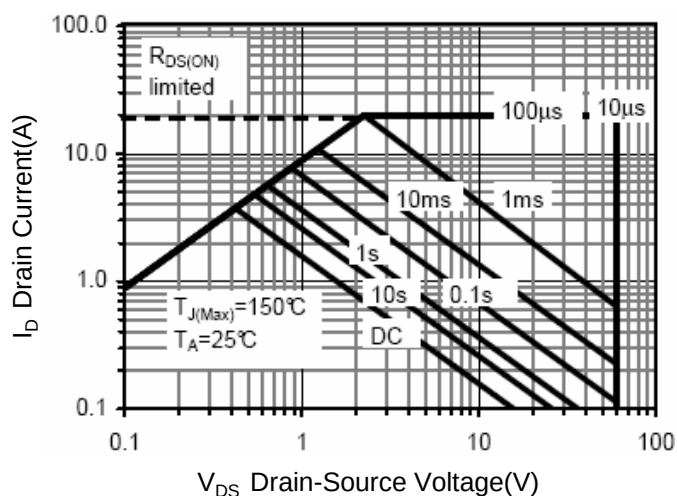
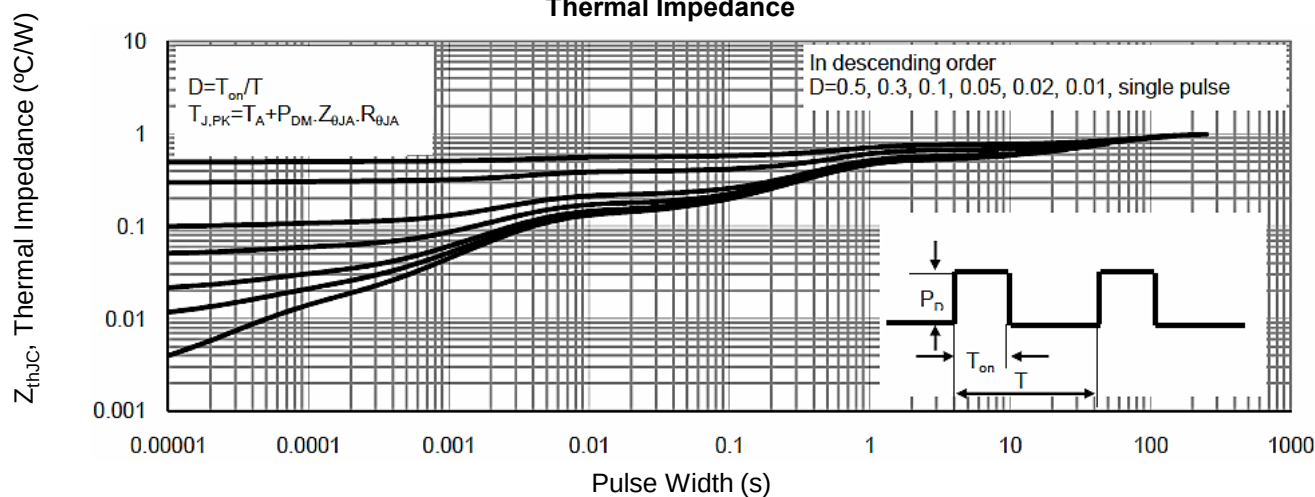


Figure 9. Normalized Maximum Transient Thermal Impedance

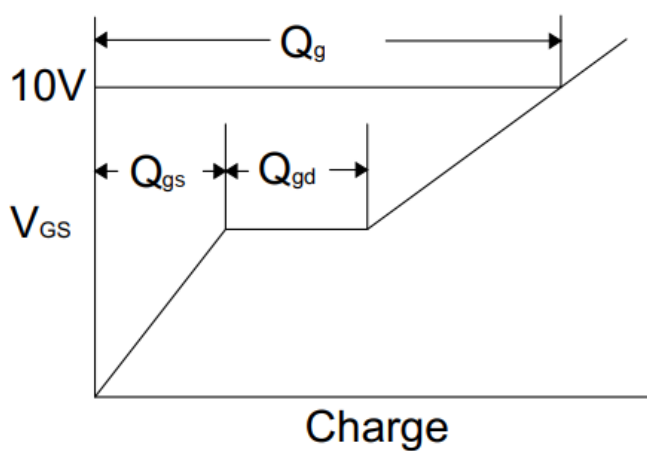
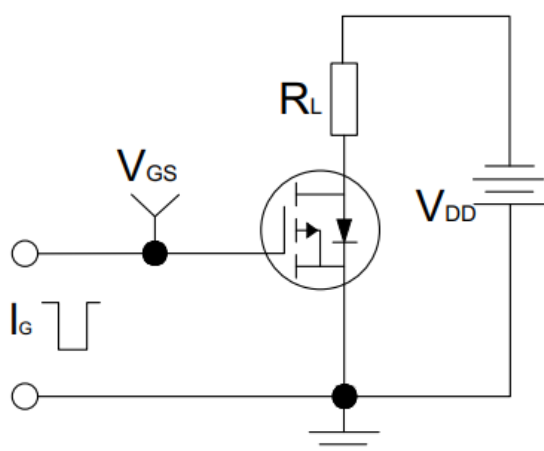


| PMOS Specifications T <sub>J</sub> = 25°C, unless otherwise noted |                      |                                                                            |       |      |      |      |
|-------------------------------------------------------------------|----------------------|----------------------------------------------------------------------------|-------|------|------|------|
| Parameter                                                         | Symbol               | Test Conditions                                                            | Value |      |      | Unit |
|                                                                   |                      |                                                                            | Min.  | Typ. | Max. |      |
| Static Parameters                                                 |                      |                                                                            |       |      |      |      |
| Drain-Source Breakdown Voltage                                    | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA                              | -60   | --   | --   | V    |
| Zero Gate Voltage Drain Current                                   | I <sub>DSS</sub>     | V <sub>DS</sub> = -60V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 25°C        | --    | --   | -1   | μA   |
| Gate-Source Leakage                                               | I <sub>GSS</sub>     | V <sub>GS</sub> = ±20V                                                     | --    | --   | ±100 | nA   |
| Gate-Source Threshold Voltage                                     | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA                | -1.0  |      | -2.5 | V    |
| Drain-Source On-Resistance                                        | R <sub>DS(on)</sub>  | V <sub>GS</sub> = -10V, I <sub>D</sub> = -3.1A                             | --    |      | 62   | mΩ   |
|                                                                   |                      | V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -0.2A                            | --    |      | 72   |      |
| Forward Transconductance                                          | g <sub>FS</sub>      | V <sub>DS</sub> =-5V,I <sub>D</sub> =-3.1A                                 | --    | 6.6  | --   | S    |
| Dynamic Parameters                                                |                      |                                                                            |       |      |      |      |
| Input Capacitance                                                 | C <sub>iss</sub>     | V <sub>GS</sub> = 0V,<br>V <sub>DS</sub> = -30V,<br>f = 1.0MHz             | --    | 1454 | --   | pF   |
| Output Capacitance                                                | C <sub>oss</sub>     |                                                                            | --    | 62   | --   |      |
| Reverse Transfer Capacitance                                      | C <sub>rss</sub>     |                                                                            | --    | 58   | --   |      |
| Total Gate Charge                                                 | Q <sub>g</sub>       | V <sub>DD</sub> = -30V,<br>I <sub>D</sub> = -3A,<br>V <sub>GS</sub> = -10V | --    | 37   | --   | nC   |
| Gate-Source Charge                                                | Q <sub>gs</sub>      |                                                                            | --    | 4.5  | --   |      |
| Gate-Drain Charge                                                 | Q <sub>gd</sub>      |                                                                            | --    | 10.5 | --   |      |
| Turn-on Delay Time                                                | t <sub>d(on)</sub>   | V <sub>DD</sub> = -30V,<br>I <sub>D</sub> = -3A,<br>R <sub>G</sub> = 3Ω    | --    | 8    | --   | ns   |
| Turn-on Rise Time                                                 | t <sub>r</sub>       |                                                                            | --    | 4    | --   |      |
| Turn-off Delay Time                                               | t <sub>d(off)</sub>  |                                                                            | --    | 32   | --   |      |
| Turn-off Fall Time                                                | t <sub>f</sub>       |                                                                            | --    | 7    | --   |      |
| Drain-Source Body Diode Characteristics                           |                      |                                                                            |       |      |      |      |
| Continuous Body Diode Current                                     | I <sub>S</sub>       | T <sub>C</sub> = 25°C                                                      | --    | --   | -3.1 | A    |
| Body Diode Voltage                                                | V <sub>SD</sub>      | T <sub>J</sub> = 25°C, I <sub>SD</sub> = -2A, V <sub>GS</sub> = 0V         | --    | --   | -1.2 | V    |

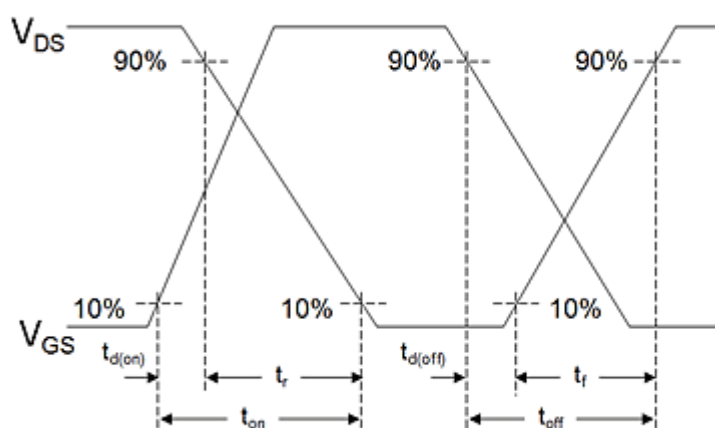
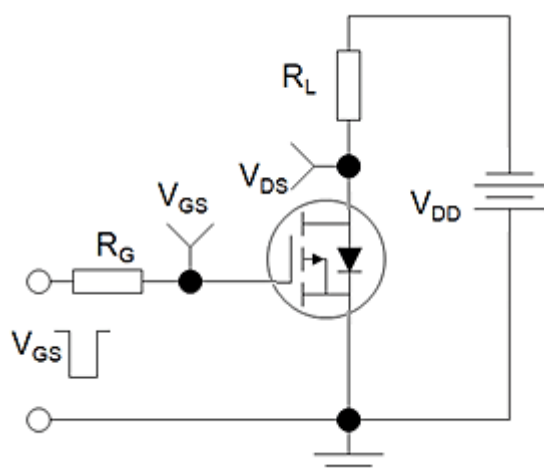
#### Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical  $R_G$

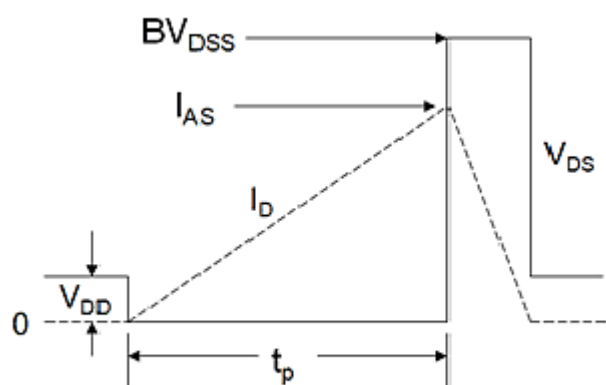
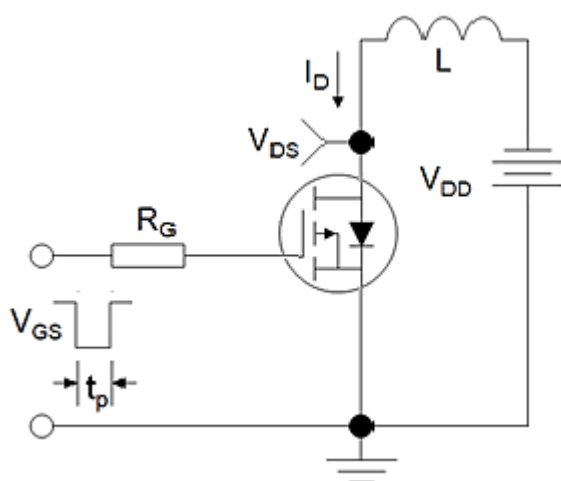
Gate Charge Test Circuit



Switch Time Test Circuit

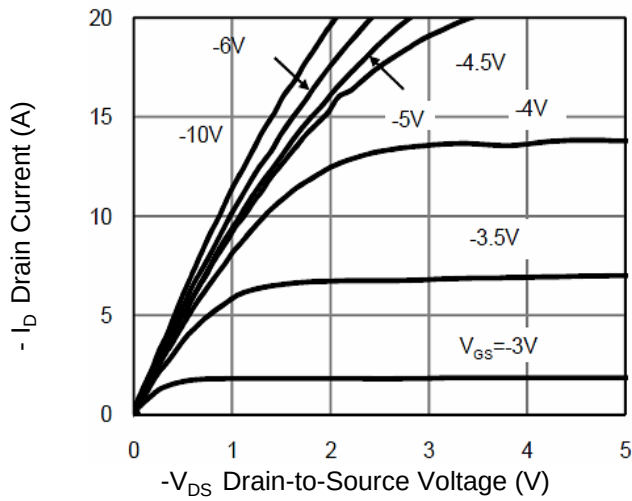


EAS Test Circuit

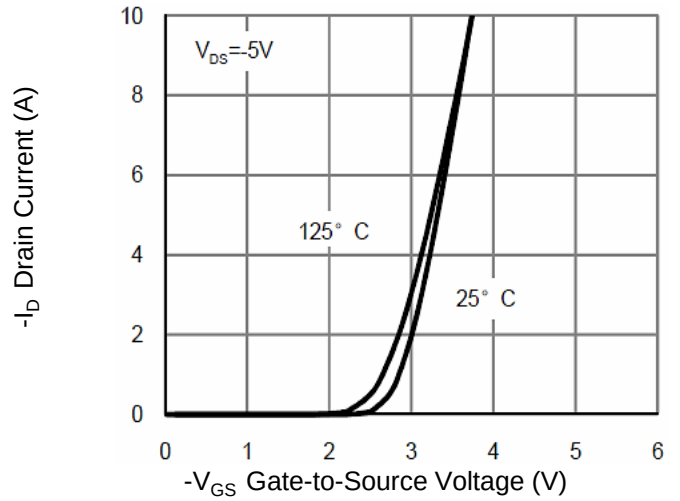


**PMOS Typical Characteristics**  $T_j = 25^\circ\text{C}$ , unless otherwise noted

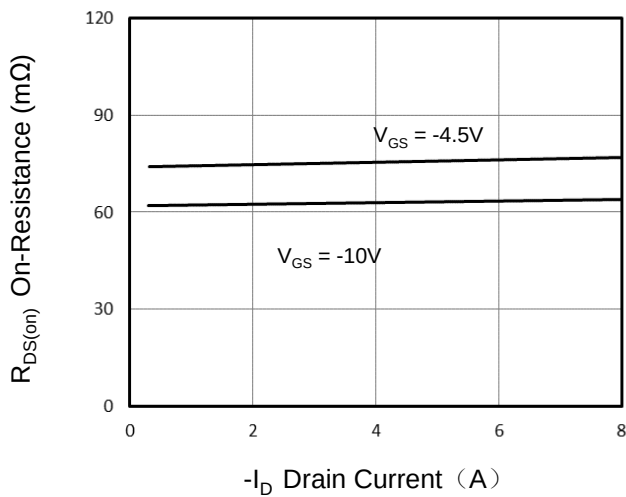
**Figure 1. Output Characteristics**



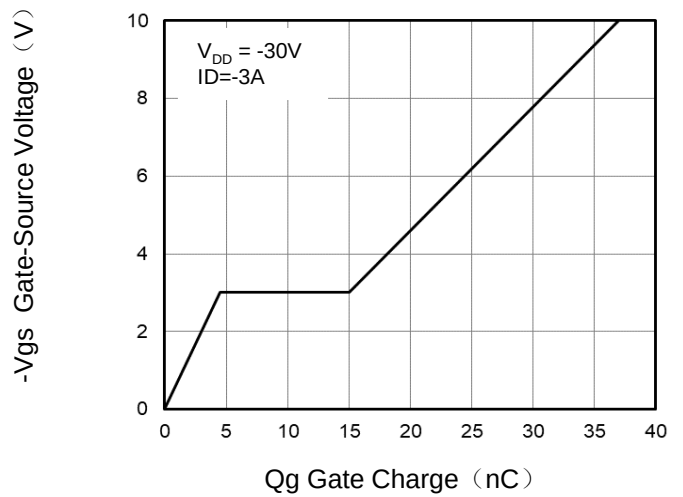
**Figure 2. Transfer Characteristics**



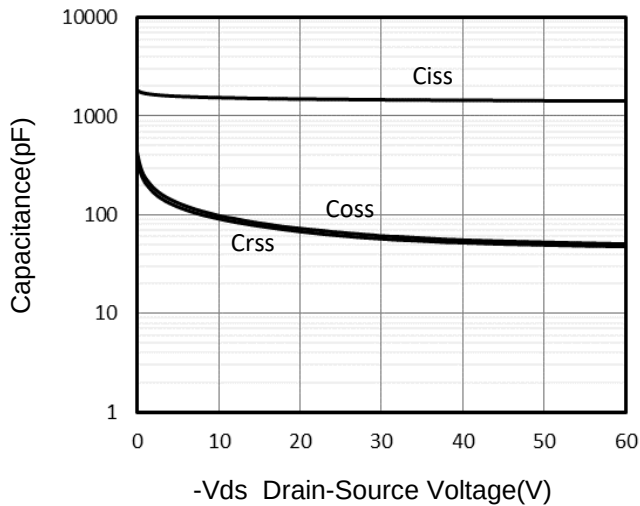
**Figure 3.  $R_{DS(on)}$ -Drain Current**



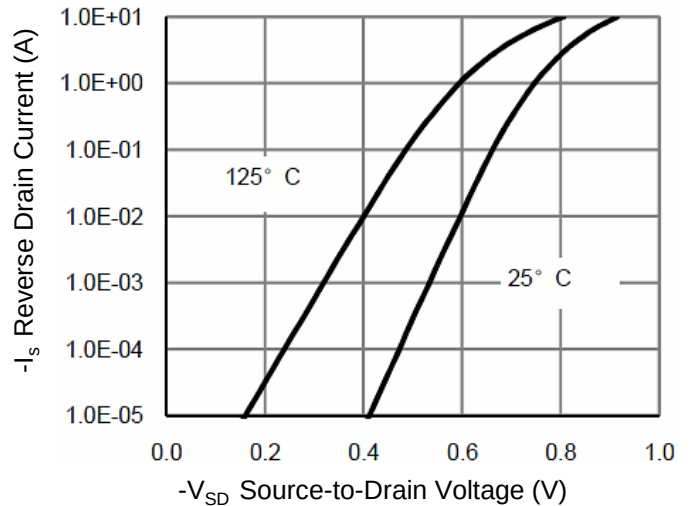
**Figure 4. Gate Charge**



**Figure 5. Capacitance**



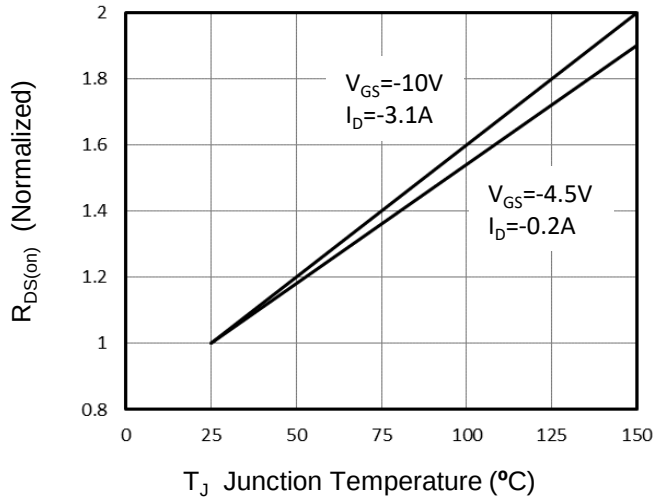
**Figure 6. Source-Drain Diode Forward**



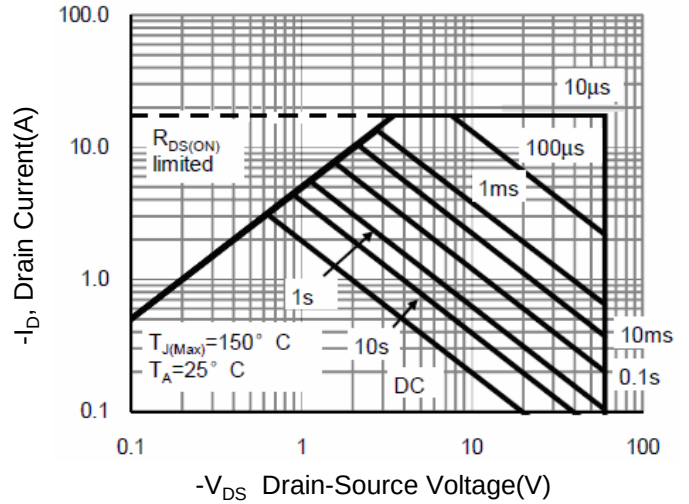


**PMOS Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

**Figure 7. Drain-Source On-Resistance**



**Figure 8. Safe Operation Area**



**Figure 9. Normalized Maximum Transient Thermal Impedance**

